

## **R276 Solder Paste**

Dispensable No-Clean Solder Paste for Leaded and Lead-free Alloys

# Product Description

Kester R276 is a no-clean solder paste specifically designed for optimal characteristics in all types of dispensing applications. R276 is available in Sn63Pb37 and Sn96.5Ag3.0Cu0.5 alloys. The flow characteristics of R276 provide for excellent dispensing characteristics with a wide range of needle diameters.

### **Performance Characteristics:**

- Available with leaded and lead-free allovs
- Compatible with Kester EP256 stenciling solder paste
- Classified as ROL0 per J-STD-004
- Compliant to Bellcore GR-78

### Standard Applications:

For Dispensing: 86% Metal for -325+500 mesh 86% Metal for -400+500 mesh



This product meets the requirements of the Restriction of Hazardous Substances (RoHS) Directive. Additional RoHS information is located at https://www.kester.com/downloads/environmental.

## Physical Properties

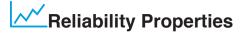
Data given for Sn96.5Ag3.0Cu0.5 86% metal, -325+500 mesh)

Viscosity (typical): 650 poise Malcom Viscometer @ 10rpm and 25°C Initial Tackiness (typical): 30 grams Tested to J-STD-005, IPC-TM-650, Method 2.4.44

Slump Test: Pass Tested to J-STD-005, IPC-TM-650, Method 2.4.35

Solder Ball Test: Preferred Tested to J-STD-005, IPC-TM-650, Method 2.4.43

Wetting Test: Pass Tested to J-STD-005, IPC-TM-650, Method 2445



Copper Mirror Corrosion: Low Tested to J-STD-004, IPC-TM-650, Method 2.3.3

Corrosion Test: Low Tested to J-STD-004, IPC-TM-650, Method 2.6.15

Silver Chromate: Pass Tested to J-STD-004, IPC-TM-650, Method 2.3.33

Chloride and Bromides: None Detected

Tested to J-STD-004, IPC-TM-650, Method 2.3.35

### Fluorides by Spot Test: Pass

Tested to J-STD-004, IPC-TM-650, Method 2.3.35.1

#### Surface Insulation Resistivity (SIR) (typical): Pass

Tested to J-STD-004, IPC-TM-650, Method 2.6.3.3

	Blank	R276
Day 1	1.0*10 <sup>10</sup> Ω	9.8*10 <sup>8</sup> Ω
Day 4	1.3*10 <sup>10</sup> Ω	1.6*10 <sup>9</sup> Ω
Day 7	1.3*10 <sup>10</sup> Ω	1.1*10 <sup>9</sup> Ω

# **Application Notes**



## Availability

R276 is available in Sn63Pb37, Sn96.5Ag3.0Cu0.5, Sn43Pb43Bi14, Sn10Pb88Ag2, Sn95.5Ag3.8Cu0.7 and Sn62Pb36Ag2 alloys with the recommended type 3 powder mesh. For specific packaging information, please refer to www.kester.com.

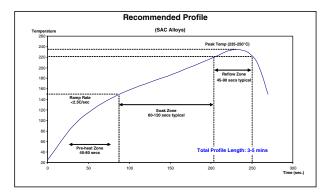
## Printing Parameters

Needle DiameterType 3 powder may be used with needle sizes down to 22 gaugeDispense SpeedCapable of at least 4 dots per secondTemperature/HumidityOptimal ranges are 21-25°C (70-77°F) and 35-65% RH

### Recommended Reflow Profile

The recommended reflow profile for R276 made with SAC alloys is shown here. This profile is simply a guideline. Since R276 is a highly active solder paste, it can solder effectively over a wide range of profiles. Your optimal profile may be different from the one shown based on you oven, board and mix of defects. Please contact Kester if you need additional profiling advice.

NOTE: The peak temperature for leaded profile should be 205-215°C degrees.



### Cleaning

R276 is a no-clean formula. The residues do not need to be removed for typical applications. Although R276 is designed for no-clean applications, its residues can be easily removed using automated cleaning equipment (in-line or batch) with a variety of readily available cleaning agents. Call Kester Technical Support for details.

### Storage and Shelf Life

Refrigeration is the recommended optimum storage condition for solder paste to maintain consistent viscosity, reflow characteristics and overall performance. R276 should be stabilized at room temperature prior to dispensing. This can be accomplished by setting the syringe out at room temperature for 1 hour. R276 should be kept at standard refrigeration conditions, 0-10°C (32-50°F). Do not place it on a hot surface. Shelf life is 6 months from date of manufacture and held at 0-10°C (32-50°F). Please contact Kester Technical Support if you require additional advice with regard storage and handling of this material.

### $\otimes$ Health and Safety

This product, during handling or use, may be hazardous to your health or the environment. Read the Safety Data Sheet and warning label before using this product. Safety Data Sheets are available at <a href="https://www.kester.com/downloads/sds">https://www.kester.com/downloads/sds</a>.